

PRODUCTION DATA SHEET

DESCRIPTION

The LX1702 family represents a Microsemi. This CMOS stereo class-D amplifier series is optimized for low applications where low consumption is desirable such as other low power systems.

The LX1702 family provides very new generation of a fully integrated low quiescent current consumption audio stereo class-D amplifier from through the use of a proprietary output modulation scheme. This technology enables filterless operation in many voltage, low power operation and applications. The LX1702 features on minimum system cost. The products board, low Rdson, complementary are ideal for use in battery powered output MOSFET's that reduces the need power for external components.

The LX1702 is offered in a small portable speakers, DVDs, PMP, and footprint, low profile, 4mm x 4mm 16pin MLPQ.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

PRODUCT HIGHLIGHT Speaker Out 1 1 PVDD OUT1-OUT1+ PVSS1 OUT2-VDD PVDD2 LX1702 IN1+ OUT2+ Speaker Out 2 IN1-PVSS2 Ш 11 ENABLE

KEY FEATURES

- No Output Filter Required
- Low EMI Design
- Low Quiescent Current: 4mA
- Low Shutdown Current: 1µA
- Wide Supply Voltage Range: 2.5-5.5 Volt
- 1W Output Power into 8Ω Load with THD<1% @ 5.0V
- THD+N as low as 0.1%
- Small Form Factor...16-pin MLP Package only 4x4mm
- **Built-in Clock Frequency**
- Built-in Feedback Loop, Keep High Audio Fidelity
- Fixed 20dB Gain
- Full 20-20KHz Audio Bandwidth
- Shutdown Function
- Internal Thermal Shutdown
- High Efficiency: over 85% through Modulation Scheme and Class-D Operation
- Built-in De-Pop Circuit

APPLICATIONS

- Portable Speakers
- Portable DVD
- PMP / PMC
- Notebook PC

•	PACKAGE ORDER INFO				
	T _A (°C)	Plastic MLPQ 4mm x 4mm 16-Pin			
		RoHS Compliant / Pb-free			
	0 to 70	LX1702CLQ			

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX1702CLQ-TR)



PRODUCTION DATA SHEET

ABSOLUTE MAXIMUM RATINGS

Positive Supply Voltage (VDD, PVDD)	
Analog Input Voltage (IN1+, IN1-, IN2+, IN2-)	0.3 to $VDD + 0.3V$
Digital Input Voltage (EN, MUTE)	0.3 to VDD + 0.3V
Operating Temperature Range (T _A)	0°C to +70°C
Maximum Operating Junction Temperature (T _J)	150°C
Storage Temperature Range	65°C to 150°C
Package Peak Temp. for Solder Reflow (40 seconds maximum	exposure) 260°C (+0 -5)

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

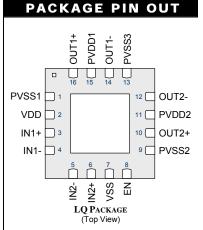
LQ Plastic MLPQ 16-Pin 4mm x 4mm

THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}

24.6°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.



RoHS / Pb-free 100% Matte Tin Lead Finish

FUNCTIONAL PIN DESCRIPTION						
Name	Description					
VSS	Negative supply to analog stage (ground)					
IN1-	Negative audio input channel 1					
IN1+	Positive audio input channel 1					
EN Enable pin, active high						
IN2-	Negative audio input channel 2					
IN2+	Positive audio input channel 2					
VDD	Analog positive power supply					
PVSS1 PVSS2 PVSS3	Negative supply to Negative output stage (ground) for channel1					
OUT1+	Positive audio (PWM) output for channel 1					
PVDD1 & PVDD2	Positive supply to Positive output stage for channel 1					
OUT1-	Negative audio (PWM) output for channel 1					
OUT2+	Positive audio (PWM) output channel 2					
OUT2-	Negative audio (PWM) output channel 2					



PRODUCTION DATA SHEET

SYSTEM CHARACTERISTICS

The following specifications apply over the operating ambient temperature $0 \le T_A \le 70^{\circ}\text{C}$ except where otherwise noted and the following test conditions: PVDD = VDD = 5.0V, PVSS = VSS = 0V, RL = 8Ω

Parameter	Symbol	Toot Co	nditions	LX1702			Units
Parameter	Symbol	Test Conditions		Min	Тур	Max	Ullits
Supply Current: Quiescent	I _{QQ}	No Load			2.5	5	mA
Supply Current: Shutdown Mode	I _{QQSD}	Disable Pin Active				1	μA
	P _Q = 1H	VDD = PVDD = 5V, Fin = 1kHz	THD+N = 1%		1.2		W
Outside Bassacia O O Observa			THD+N = 10%		1.6		
Output Power @ 8 Ohms		VDD = PVDD = 3.3V.	THD+N = 1%		0.45		
		Fin = 1kHz	THD+N = 10%		0.6		
Power Efficiency	Н	VDD = PVDD = 5V, Fin = 1kHz			85		%
Total Harmonic Distortion @ 50% of Maxim Power	THD_N	VDD = PVDD = 5V, Fin = 1kHz, $R_L = 8\Omega$			0.1		%
Signal To Noise Ratio	SNR	VDD = PVDD = 5V, F = 1kHz, P ₀ = 0.5W, A-weighted			90		dB
Output Noise Floor	V_N	Input Grounded A-weighted 20 to 20kHz			100		μV_{RMS}
Frequency Response Lower Corner Frequency	F _{LO}	3dB relative to 1kHz		20		20K	Hz
Frequency Response		VDD = PVDD = 2.5 to 5.5V, RL = 8Ω, P _O = 200mW @ 20 ~ 80kHz, Filter less				3	dB
Power Supply Rejection Ratio	PSRR	Input Reffered, VDD = PVDD = 2.5V to 5.5V		55	60		dB
Common Mode Rejection Ratio	CMRR	VDD = PVDD = 2.5V to 5.5V		55	60		dB
Gain	G _{SYS}				20		dB

Page 4



1W Filter less Stereo Class-D Amplifier

PRODUCTION DATA SHEET

ELECTRICAL CHARACTERISTICS

The following specifications apply over the operating ambient temperature $0 \le T_A \le 70^{\circ}\text{C}$ except where otherwise noted and the following test conditions: PVDD = VDD = 5.0V, PVSS = VSS = 0V, RL = 8Ω

Parameter	Symbol	Symbol Test Conditions		LX1702		Units	
raiametei	Symbol Test Conditions		Min	Тур	Max	Ullits	
Supply Voltage	VDD PVDD	o j		2.5		5.5	V
Oscillator Frequency	f _{SW}	VDD = PVDD = 2.5 ~ 5.5V			200		kHz
Supply Current: Quicecent	,	No Load	VDD = PVDD = 5V		2.5	5	mA
Supply Current: Quiescent	I _{QQ}	NO LOAU	VDD = PVDD = 3.3V		2	4	
Supply Current: Shutdown Mode	I _{QQSD}	Disable Pin Active			0.5	2	μA
Power Supply Rejection Ratio	PSRR	VDD = PVDD = 2.5V to	5.5V	55	60		dB
Input Resistance	R _{IN}	VDD = PVDD = 2.5V ~ 5.5V Single Ended			18		ΚΩ
Output DC Offset	V_{OFF}	Input Shorted to GND		-50		+50	mV
	RDSON	VDD = PVDD = 5V	P Channel		400		mΩ
			N Channel		400		
Static Drain-to-Source ON-		VDD = PVDD = 3.3V	P Channel		550		
Resistance			N Channel		550		
		VDD = PVDD = 2.5V	P Channel			900	
			N Channel			900	
Stage Gain	G _H	VDD = PVDD = 2.5V to 5.5V		9	10	11	V/V
Thermal Junction Shutdown	TJ				150		°C
Thermal Shutdown Hysteresis					25		°C
Enable Threshold	EN			2.1	2.25	2.4	V
Under Voltage Threshold Level	V_{DD}			1.8	2.0	2.2	V

SIMPLIFIED BLOCK DIAGRAM

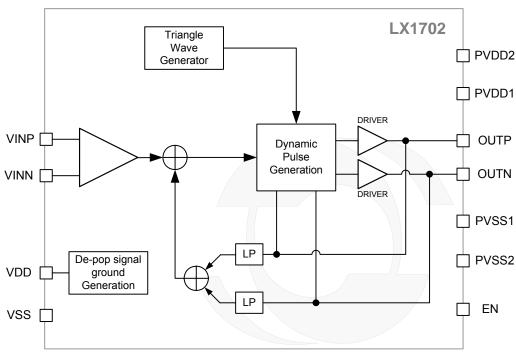


Figure 1 - LX1702 Simplified Block Diagram (Half Circuit)



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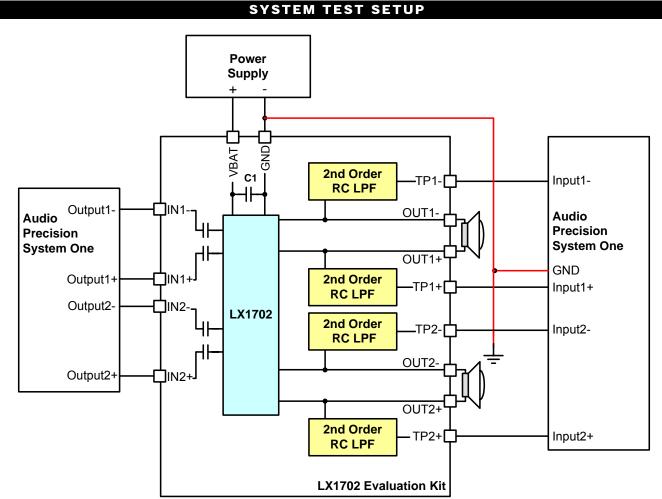


Figure 2 - Typical Evaluation Test Setup Circuit

Default Settings:

Equipments: Audio Precision SYSTEM 1

Oscilloscope,

Power Supply ~ +5V; Supply Voltage: 2.5V / 3.3V / 5.0V 3 corner voltages On-Board passive LPF: 40kHz cut off frequency (-6dB)

AP settings: 10Hz ~ 22KHz BPF



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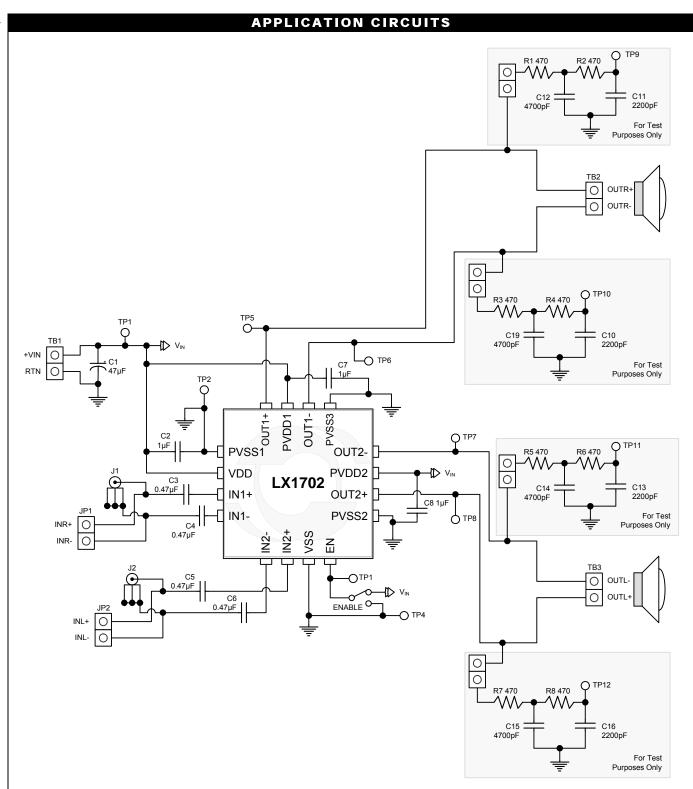


Figure 3 – Typical LX1702 Application



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FUNCTIONAL DESCRIPTION

GENERAL DESCRIPTION

The LX1702 is a filterless, low-EMI, class-D audio power amplifier. It offers high performance (THD+N is just 0.1% @ 1W), high efficiency (>85% @ 0.6W), and best in class EMI radiation (just 20dB μ V/m). The internal signal path is completely differential to minimize common-mode noise pickup. The inputs may be driven single-ended or differentially and they may be direct or AC coupled. The LX1702 may be operated with just a single decoupling capacitor.

FILTERLESS 3-LEVEL CLASS-D MODULATION

The LX1702 output stage is configured as a full H-bridge push-pull driver. The speaker must be driven differentially from the OUTP and OUTN pins. Each side of the speaker is driven by a 200KHz switching signal that transitions between V_{DD} and GND. With zero input voltage, the duty cycle at each output is around 50% and the signals are inphase with each other. In this case, there is basically no differential voltage across the speaker. When the input signal goes positive, the duty cycle at OUTP increases above 50% and the duty cycle at OUTN decreases below 50%. This causes a net positive current to flow into the speaker. A negative input voltage causes the OUTN duty cycle to increase and the OUTP duty cycle to decrease which causes a net negative current to flow into the speaker. The differential voltage across the speaker has a fundamental frequency of twice the 200KHz switching frequency. The speaker itself serves as the low pass filter which then recreates the audio signal. This type of modulation can be described as driving $+V_{DD}$, $-V_{DD}$, and 0Vacross the speaker which is why it is referred to as 3-Level modulation.

Classical, 2-Level modulation drives either $+V_{DD}$ or $-V_{DD}$ across the speaker at all times. This scheme requires an L-C filter between the amplifier's outputs and the speaker in order to keep the output current low.

LOW-EMI OUTPUT STAGE WITH SLEW RATE LIMITING AND ACTIVE OVERSHOOT CLAMPING

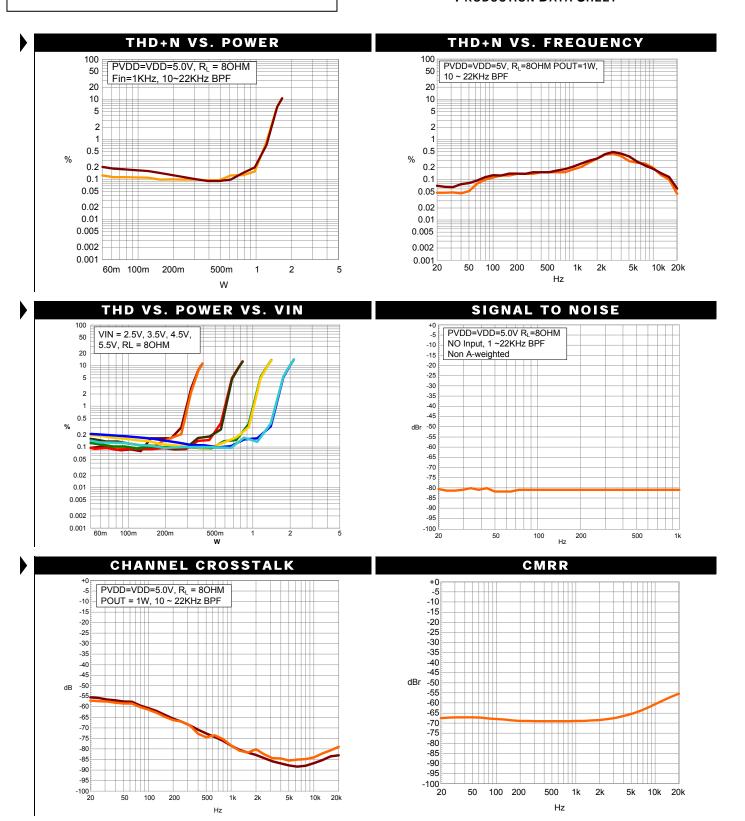
With 3-Level modulation, the carrier frequency drives a full amplitude common-mode signal to the speaker wires. This can cause high EMI radiation. One way to combat this would be to filter the outputs with LC filters or ferrite beads located close to the amplifier. In the LX1702, the output stage has been carefully designed to minimize EMI radiation so that these types of filters are not required. Slew rate limiting is used to keep the outputs from switching too quickly. Active overshoot clamping is used to minimize the inductive overshoot which occurs at each transition. These two techniques allow the LX1702 to easily meet FCC standards for radiated emissions when driving up to 3 meters of speaker wire.

DIFFERENTIAL SIGNAL PATH, WIDE DYNAMIC RANGE, AND BUILT-IN THERMAL OVERLOAD PROTECTION

The fully differential signal path uses Pulse Width Modulation and multiple feedback loops to provide high performance and low distortion. This is all fully-integrated to eliminate the need for any external feedback components or filters. The gain is fixed by internal resistors at 20dB. The differential signal path and internal voltage boosters allow for wide dynamic range. In fact, the LX1702 can be operated from supplies as low as 2.5V and as high as 5.5V. The output power will be limited by the available supply voltage. An internal thermal sensing circuit shuts down the outputs when the junction temperature exceeds about 150°C to provide thermal overload protection.

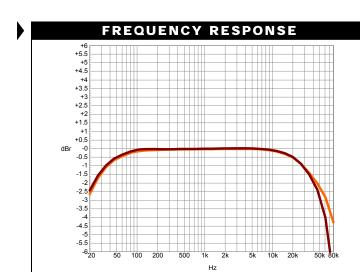


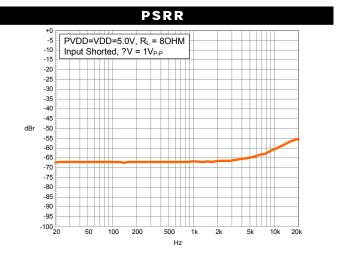
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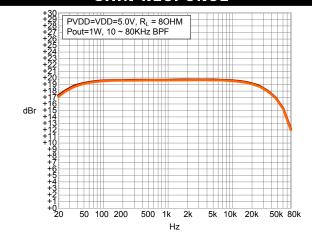


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GAIN RESPONSE

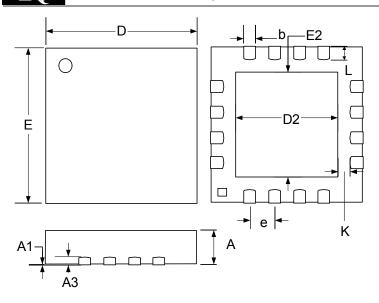




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PACKAGE DIMENSIONS

16-Pin MLPQ Plastic (4x4mm EP / 114x114Cu Exposed Pad)



	MILLIM	ETERS	INCHES		
Dim	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0	0.05	0	0.002	
A3	0.18	0.30	0.007	0.012	
b	0.23	0.38	0.009	0.015	
D	4.00	4.00 BSC		BSC	
Е	4.00	4.00 BSC		BSC	
е	0.65	0.65 BSC		BSC	
D2	2.55	2.80	0.100	0.110	
E2	2.55	2.80	0.100	0.110	
K	0.20	-	0.008	-	
L	0.30	0.50	0.012	0.020	

Note:

 Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.



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NOTES

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